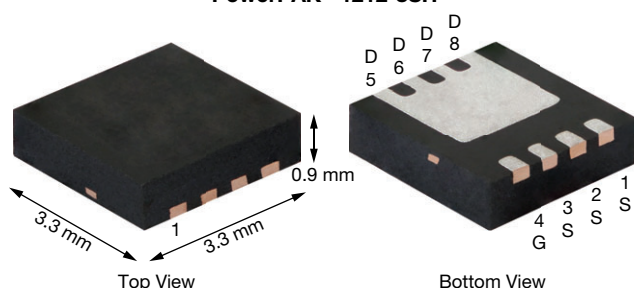


# N-Channel 30 V (D-S) Fast Switching MOSFET

**PowerPAK® 1212-8SH**


## FEATURES

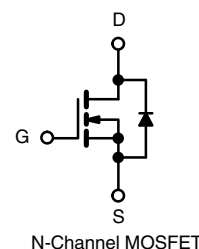
- TrenchFET® power MOSFET
- 100 %  $R_g$  tested
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

## APPLICATIONS

- Synchronous rectification
- Load switch



| PRODUCT SUMMARY                                    |        |
|----------------------------------------------------|--------|
| $V_{DS}$ (V)                                       | 30     |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10$ V  | 0.0075 |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5$ V | 0.0082 |
| $Q_g$ typ. (nC)                                    | 18     |
| $I_D$ (A)                                          | 17.8   |
| Configuration                                      | Single |

| ORDERING INFORMATION            |                  |
|---------------------------------|------------------|
| Package                         | PowerPAK 1212-8  |
| Lead (Pb)-free and halogen-free | SiSH112DN-T1-GE3 |

| ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25 °C, unless otherwise noted) |                        |                 |                                   |             |              |      |
|---------------------------------------------------------------------------|------------------------|-----------------|-----------------------------------|-------------|--------------|------|
| PARAMETER                                                                 |                        |                 | SYMBOL                            | 10 S        | STEADY STATE | UNIT |
| Drain-source voltage                                                      |                        |                 | V <sub>DS</sub>                   | 30          | 30           | V    |
| Gate-source voltage                                                       |                        |                 | V <sub>GS</sub>                   | ±12         | ±12          |      |
| Continuous drain current (T <sub>J</sub> = 150 °C) <sup>a</sup>           | T <sub>C</sub> = 25 °C | I <sub>D</sub>  | 17.8                              | 11.3        | A            |      |
|                                                                           | T <sub>C</sub> = 70 °C |                 | 14.2                              | 9.1         |              |      |
| Pulsed drain current                                                      |                        | I <sub>DM</sub> | 60                                | 60          |              |      |
| Continuous source current (diode conduction) <sup>a</sup>                 |                        | I <sub>S</sub>  | 3.2                               | 1.3         |              |      |
| Single avalanche current                                                  | L = 0.1 mH             | I <sub>AS</sub> | 20                                | 20          | mJ           |      |
| Single avalanche energy                                                   |                        | E <sub>AS</sub> | 20                                | 20          |              |      |
| Maximum power dissipation <sup>a</sup>                                    | T <sub>C</sub> = 25 °C | P <sub>D</sub>  | 3.8                               | 1.5         | W            |      |
|                                                                           | T <sub>C</sub> = 70 °C |                 | 2                                 | 0.8         |              |      |
| Operating junction and storage temperature range                          |                        |                 | T <sub>J</sub> , T <sub>stg</sub> | -50 to +150 |              | °C   |
| Soldering recommendations (peak temperature) <sup>b, c</sup>              |                        |                 |                                   | 260         |              |      |

## Notes

- Surface mounted on 1" x 1" FR4 board
- See solder profile ([www.vishay.com/doc?73257](http://www.vishay.com/doc?73257)). The PowerPAK 1212-8SH is a leadless package within the PowerPAK 1212-8 package family. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

**THERMAL RESISTANCE RATINGS**

| PARAMETER                                |               | SYMBOL     | TYPICAL | MAXIMUM | UNIT |
|------------------------------------------|---------------|------------|---------|---------|------|
| Maximum junction-to-ambient <sup>a</sup> | $t \leq 10$ s | $R_{thJA}$ | 24      | 33      | °C/W |
|                                          | Steady state  |            | 65      | 81      |      |
| Maximum junction-to-foot (drain)         | Steady state  | $R_{thJC}$ | 1.9     | 2.4     |      |

**Note**

a. Surface mounted on 1" x 1" FR4 board

**SPECIFICATIONS** ( $T_J = 25$  °C, unless otherwise noted)

| PARAMETER                                     | SYMBOL       | TEST CONDITIONS                                                                               | MIN. | TYP.   | MAX.      | UNIT     |
|-----------------------------------------------|--------------|-----------------------------------------------------------------------------------------------|------|--------|-----------|----------|
| <b>Static</b>                                 |              |                                                                                               |      |        |           |          |
| Gate threshold voltage                        | $V_{GS(th)}$ | $V_{DS} = V_{GS}$ , $I_D = 250$ $\mu$ A                                                       | 0.6  | -      | 1.5       | V        |
| Gate-body leakage                             | $I_{GSS}$    | $V_{DS} = 0$ V, $V_{GS} = \pm 12$ V                                                           | -    | -      | $\pm 100$ | nA       |
| Zero gate voltage drain current               | $I_{DSS}$    | $V_{DS} = 30$ V, $V_{GS} = 0$ V                                                               | -    | -      | 1         | $\mu$ A  |
|                                               |              | $V_{DS} = 30$ V, $V_{GS} = 0$ V, $T_J = 55$ °C                                                | -    | -      | 5         |          |
| On-state drain current <sup>a</sup>           | $I_{D(on)}$  | $V_{DS} \geq 5$ V, $V_{GS} = 10$ V                                                            | 40   | -      | -         | A        |
| Drain-source on-state resistance <sup>a</sup> | $R_{DS(on)}$ | $V_{GS} = 10$ V, $I_D = 17.8$ A                                                               | -    | 0.0060 | 0.0075    | $\Omega$ |
|                                               |              | $V_{GS} = 4.5$ V, $I_D = 17$ A                                                                | -    | 0.0065 | 0.0082    |          |
| Forward transconductance <sup>a</sup>         | $g_{fs}$     | $V_{DS} = 15$ V, $I_D = 17.8$ A                                                               | -    | 97     | -         | S        |
| Diode forward voltage <sup>a</sup>            | $V_{SD}$     | $I_S = 3.2$ A, $V_{GS} = 0$                                                                   | -    | 0.7    | 1.2       | V        |
| <b>Dynamic <sup>b</sup></b>                   |              |                                                                                               |      |        |           |          |
| Input capacitance                             | $C_{iss}$    | $V_{DS} = 15$ V, $V_{GS} = 0$ V, $f = 1$ MHz                                                  | -    | 2610   | -         | pF       |
| Output capacitance                            | $C_{oss}$    |                                                                                               | -    | 340    | -         |          |
| Reverse transfer capacitance                  | $C_{rss}$    |                                                                                               | -    | 145    | -         |          |
| Total gate charge                             | $Q_g$        | $V_{DS} = 15$ V, $V_{GS} = 4.5$ V, $I_D = 17.8$ A                                             | -    | 18     | 27        | nC       |
| Gate-source charge                            | $Q_{gs}$     |                                                                                               | -    | 6.2    | -         |          |
| Gate-drain charge                             | $Q_{gd}$     |                                                                                               | -    | 3.1    | -         |          |
| Gate resistance                               | $R_g$        | $f = 1$ MHz                                                                                   | 0.5  | 1.2    | 1.8       | $\Omega$ |
| Turn-on delay time                            | $t_{d(on)}$  | $V_{DD} = 15$ V, $R_L = 15$ $\Omega$<br>$I_D \cong 1$ A, $V_{GEN} = 10$ V, $R_g = 6$ $\Omega$ | -    | 10     | 15        | ns       |
| Rise time                                     | $t_r$        |                                                                                               | -    | 10     | 15        |          |
| Turn-off delay time                           | $t_{d(off)}$ |                                                                                               | -    | 65     | 100       |          |
| Fall time                                     | $t_f$        |                                                                                               | -    | 10     | 15        |          |
| Body diode reverse recovery time              | $t_{rr}$     | $I_F = 3.2$ A, $di/dt = 100$ A/ $\mu$ s                                                       | -    | 30     | 60        | nC       |
| Body diode reverse recovery charge            | $Q_{rr}$     |                                                                                               | -    | 18     | -         |          |

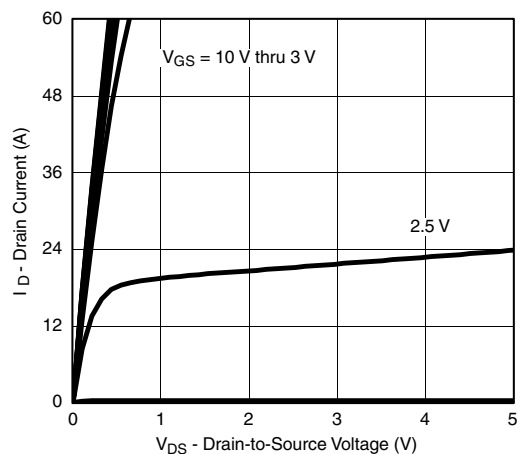
**Notes**

- a. Pulse test; pulse width  $\leq 300$   $\mu$ s, duty cycle  $\leq 2$  %  
b. Guaranteed by design, not subject to production testing

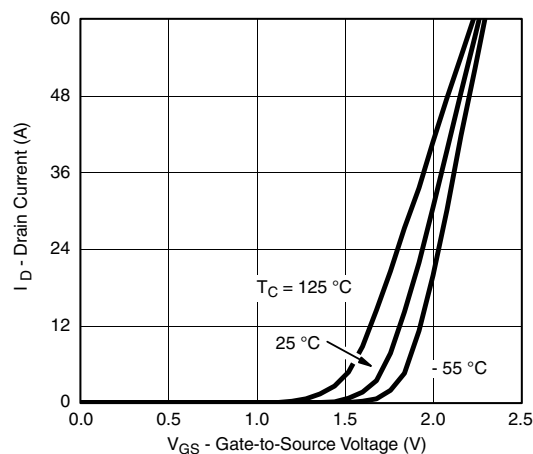
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



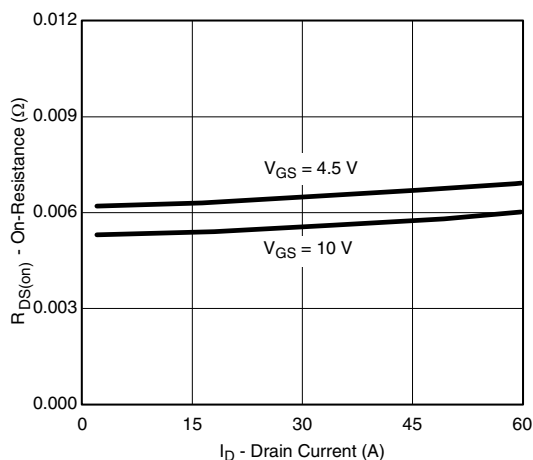
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



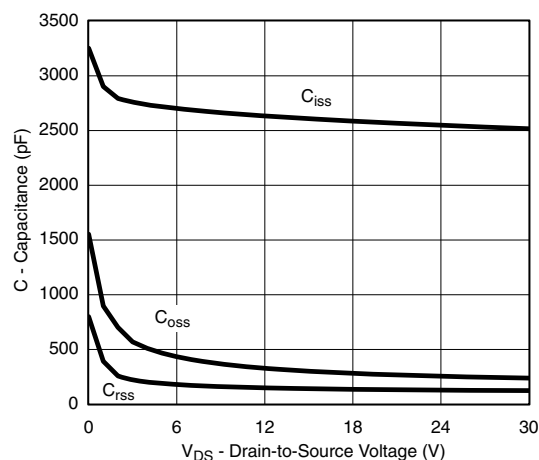
**Output Characteristics**



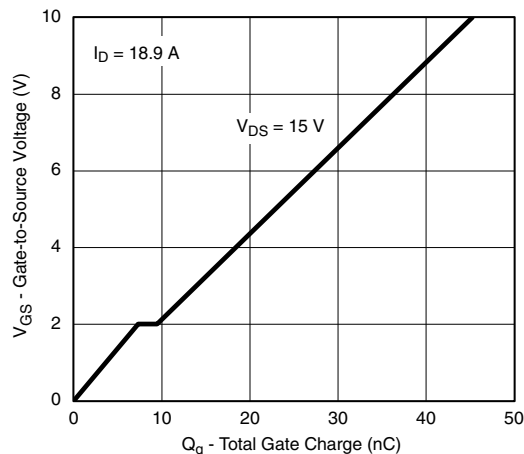
**Transfer Characteristics**



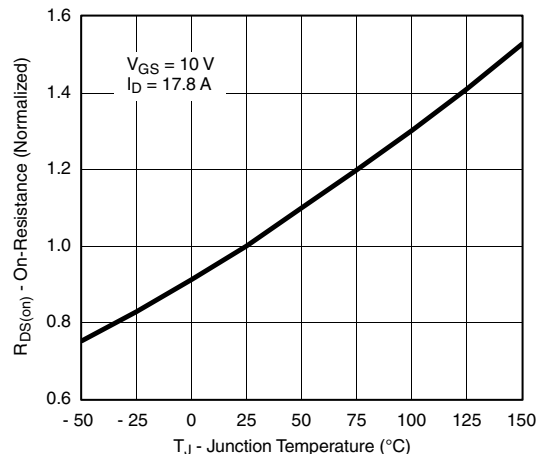
**On-Resistance vs. Drain Current**



**Capacitance**



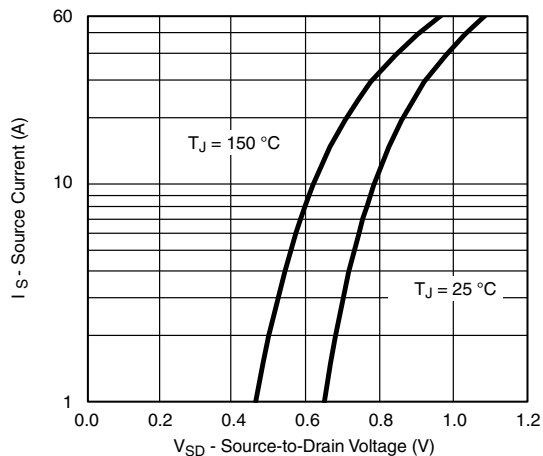
**Gate Charge**



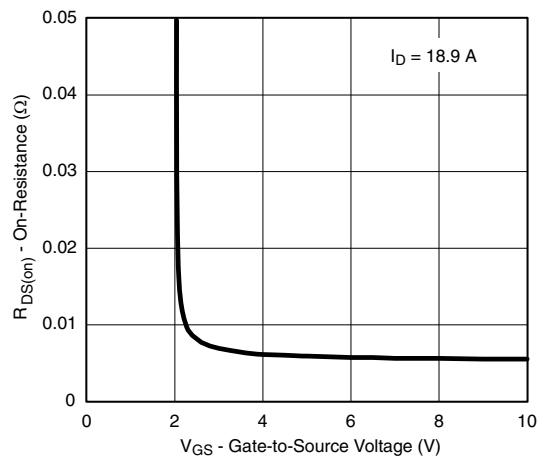
**On-Resistance vs. Junction Temperature**



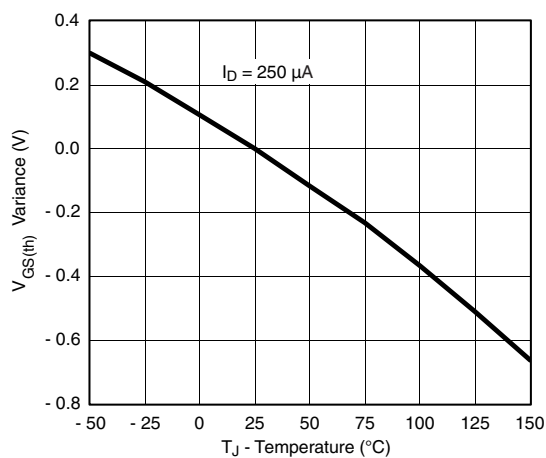
**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



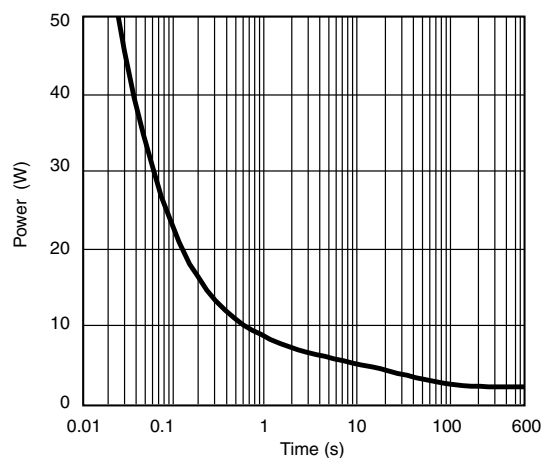
**Source-Drain Diode Forward Voltage**



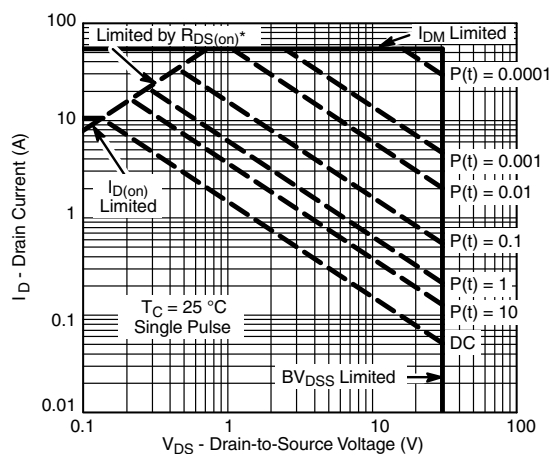
**On-Resistance vs. Gate-to-Source Voltage**



**Threshold Voltage**



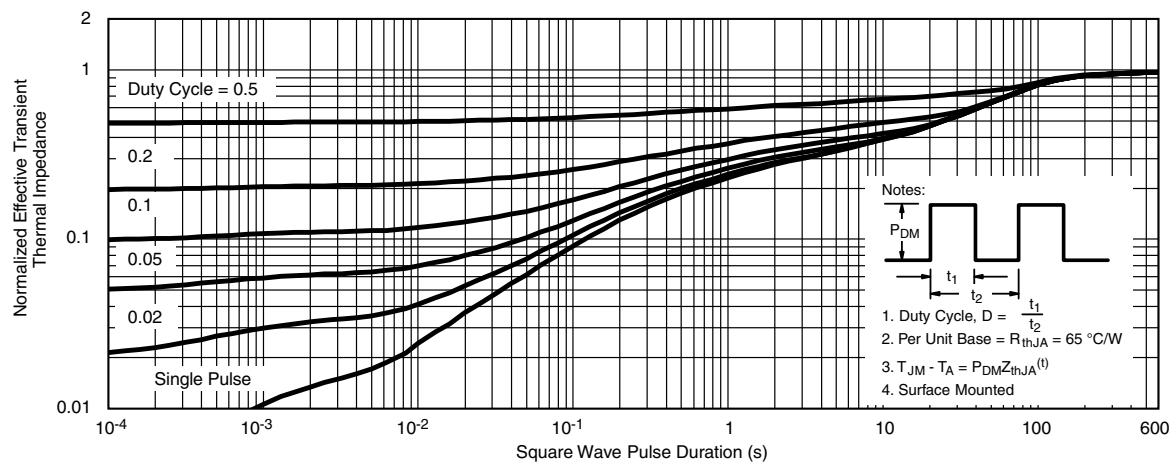
**Single Pulse Power, Junction-to-Ambient**



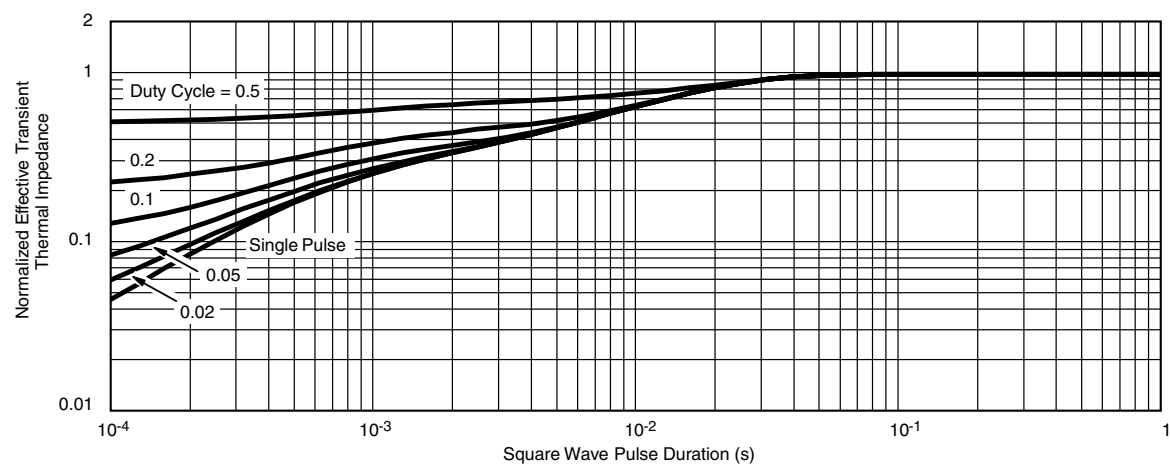
**Safe Operating Area, Junction-to-Ambient**



**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)



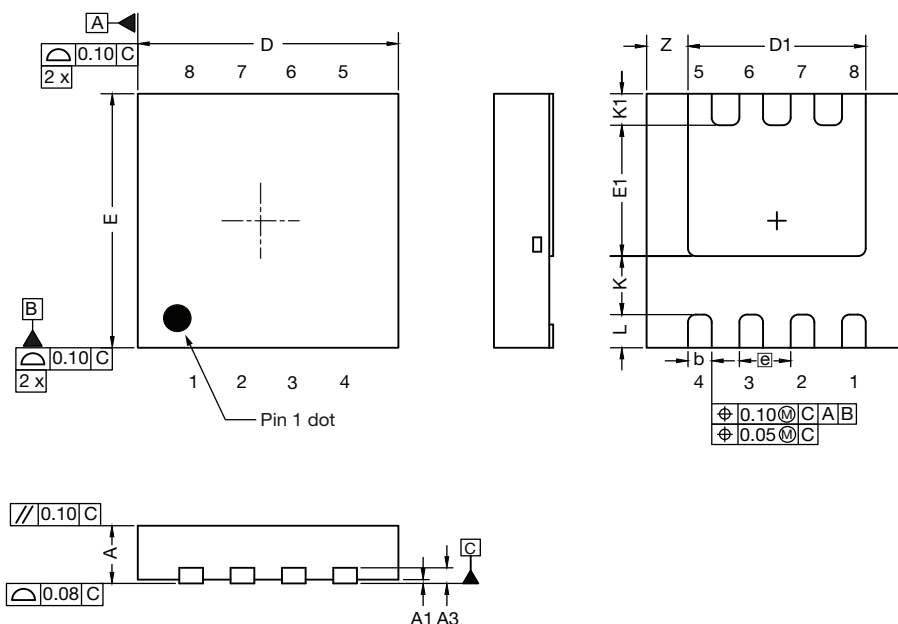
**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Case**

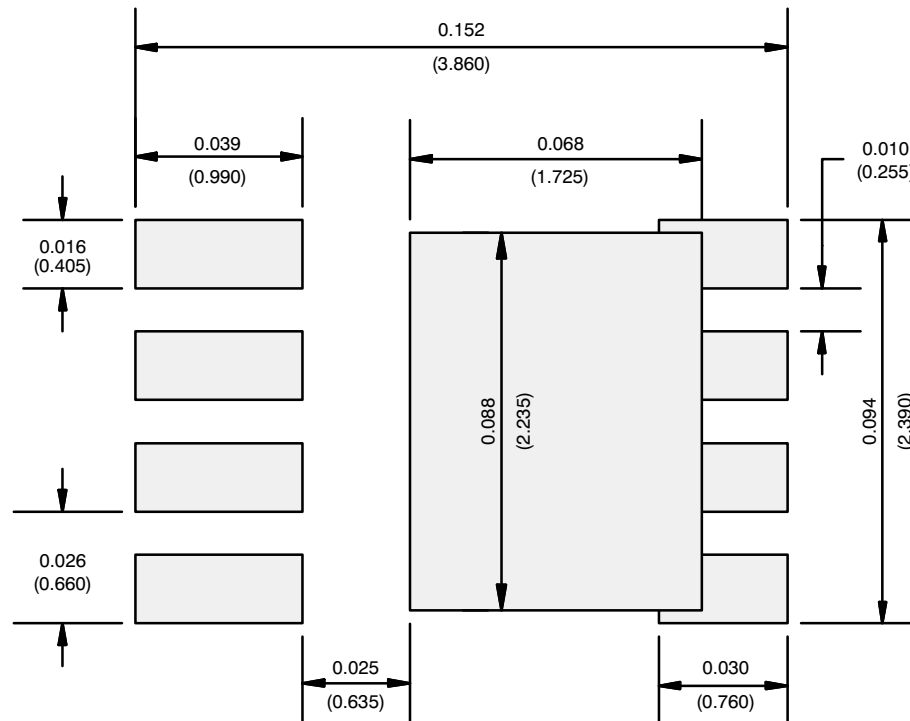
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## Case Outline for PowerPAK® 1212-SWLH



| DIM.                              | MILLIMETERS |      |      | INCHES     |       |       |
|-----------------------------------|-------------|------|------|------------|-------|-------|
|                                   | MIN.        | NOM. | MAX. | MIN.       | NOM.  | MAX.  |
| A                                 | 0.82        | 0.90 | 0.98 | 0.032      | 0.035 | 0.038 |
| A1                                | 0.00        | -    | 0.05 | 0.000      | -     | 0.002 |
| A3                                | 0.20 ref.   |      |      | 0.008 ref. |       |       |
| b                                 | 0.25        | 0.30 | 0.35 | 0.010      | 0.012 | 0.014 |
| D                                 | 3.20        | 3.30 | 3.40 | 0.126      | 0.130 | 0.134 |
| D1                                | 2.15        | 2.25 | 2.35 | 0.085      | 0.089 | 0.093 |
| E                                 | 3.20        | 3.30 | 3.40 | 0.126      | 0.130 | 0.134 |
| E1                                | 1.60        | 1.70 | 1.80 | 0.063      | 0.067 | 0.071 |
| e                                 | 0.65 bsc.   |      |      | 0.026 bsc. |       |       |
| K                                 | 0.76 ref.   |      |      | 0.030 ref. |       |       |
| K1                                | 0.41 ref.   |      |      | 0.016 ref. |       |       |
| L                                 | 0.33        | 0.43 | 0.53 | 0.013      | 0.017 | 0.021 |
| Z                                 | 0.525 ref.  |      |      | 0.021 ref. |       |       |
| ECN: C20-0863-Rev. B, 20-Jul-2020 |             |      |      |            |       |       |
| DWG: 6062                         |             |      |      |            |       |       |

## RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads  
Dimensions in Inches/(mm)

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